

## March 2013

# **FL7930** Single-Stage Flyback and Boundary-Mode PFC **Controller for Lighting**

## **Features**

- Additional PFC-Ready Function (FL7930C Only)
- -Input-Voltage-Absent-Detection Circuit
- Maximum Switching Frequency Limitation
- Internal Soft-Start with Overshoot Prevention
- Internal Total Harmonic Distortion (THD) Optimizer
- Precise Adjustable Output Over-Voltage Protection
- Additional OVP Detection Pin (FL7930B Only)
- **Open-Feedback Protection and Disable Function**
- Zero-Current Detector
- 150 µs Internal Startup Timer
- MOSFET Over-Current Protection (OCP)
- Under-Voltage Lockout with 3.5 V Hysteresis
- Low Startup and Operating Current
- Totem-Pole Output with High State Clamp
- +500/-800 mA Peak Gate Drive Current
- 8-Pin Small Outline Package (SOP)

## Applications

- Ballast
- General LED Lighting
- Industrial, Commercial, and Residential Fixtures
- Outdoor Lighting: Street, Roadway, Parking, Construction and Ornamental LED Lighting Fixtures

## Description

The FL7930 is an active Power Factor Correction (PFC) controller for low-to high-power lumens applications that operate in Critical Conduction Mode (CRM). It uses a voltage-mode PWM that compares an internal ramp signal with the error amplifier output to generate a MOSFET turn-off signal. Because the voltage-mode CRM PFC controller does not need rectified AC line voltage information, it saves the power loss of an input voltage-sensing network necessary for a current-mode CRM PFC controller.

FL7930 provides over-voltage, open-feedback, overcurrent, input-voltage-absent detection, and undervoltage lockout protections. The FL7930 can be disabled if the INV pin voltage is lower than 0.45 V and the operating current decreases to a very low level. Using a new variable on-time control method, THD is lower than the conventional CRM boost PFC ICs.

The FL7930B provides an additional OVP pin that can be used to shut down the boost power stage when output voltage exceeds the OVP level due to damaged resistors connected at the INV pin. The FL7930C provides a PFC-ready pin can be used to trigger other power stages when PFC output voltage reaches the proper level (with hysteresis).

Ordering Info	ormation			
Part Number	Operating Temperature Range	Top Mark	Package	Packing Method
FL7930BMX	-40 to +125°C	FL7930B	8-Lead Small Outline Package (SOP)	Tape & Reel
FL7930CMX	-40 10 + 125 C	FL7930C	o-Leau Sman Outline Fackage (SOF)	Tape & Reel







## **Pin Definitions**

Pin #	Name	Description
1	INV	This pin is the inverting input of the error amplifier. The output voltage of the boost PFC converter should be resistively divided to 2.5 V.
	OVP	<b>FL7930B</b> : This pin is used to detect PFC output over-voltage when INV pin information is not correct.
2	RDY	<b>FL7930C</b> : This pin is used to detect PFC output-voltage reaching a pre-determined value. When output voltage reaches 89% of rated output voltage, this pin is pulled HIGH, which is an (open-drain) output type.
3	COMP	This pin is the output of the transconductance error amplifier. Components for the output voltage compensation should be connected between this pin and GND.
4	CS	This pin is the input of the over-current protection comparator. The MOSFET current is sensed using a sensing resistor and the resulting voltage is applied to this pin. An internal RC filter is included to filter switching noise.
5	ZCD	This pin is the input of the zero-current detection block. If the voltage of this pin goes higher than 1.5 V, then goes lower than 1.4 V, the MOSFET is turned on.
6	GND	This pin is used for the ground potential of all the pins. For proper operation, the signal ground and the power ground should be separated.
7	OUT	This pin is the gate drive output. The peak sourcing and sinking current levels are +500 mA and -800mA, respectively. For proper operation, the stray inductance in the gate driving path must be minimized.
8	VCC	This is the IC supply pin. IC current and MOSFET drive current are supplied using this pin.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage			Vz	V
I <sub>OH</sub> , I <sub>OL</sub>	Peak Drive Output Current	Peak Drive Output Current		+500	mA
ICLAMP	Driver Output Clamping Diodes	$V_{\rm O}$ >V <sub>CC</sub> or V <sub>O</sub> <-0.3 V	-10	+10	mA
IDET	Detector Clamping Diodes		-10	+10	mA
	Error Amplifier Input, Output, OV	P Input, ZCD, RDY, and OVP Pins <sup>(1)</sup>	-0.3	8.0	N
V <sub>IN</sub>	CS Input Voltage <sup>(2)</sup>		-10	6	V
TJ	Operating Junction Temperature			+150	°C
T <sub>A</sub>	Operating Temperature Range		-40	+125	°C
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
ESD	Electrostatic Discharge	Human Body Model, JESD22-A114		2.5	kV
E9D	Capability	Charged Device Model, JESD22-C101		2.0	κv

## Notes:

1. When this pin is supplied by external power sources by accident, its maximum allowable current is 50 mA.

2. In case of DC input, acceptable input range is -0.3 V~6 V: within 100 ns -10 V~6 V is acceptable, but electrical specifications are not guaranteed during such a short time.

## Thermal Impedance

Symbol	Parameter	Min.	Max.	Unit
$\Theta_{JA}$	Thermal Resistance, Junction-to-Ambient <sup>(3)</sup>	150		°C/W

Note:

3. Regarding the test environment and PCB type, please refer to JESD51-2 and JESD51-10.

## **Electrical Characteristics**

 $V_{CC}$  = 14 V,  $T_A$  = -40°C to +125°C, unless otherwise specified.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
V <sub>cc</sub> Section					1	
V <sub>START</sub>	Start Threshold Voltage	V <sub>cc</sub> Increasing	11	12	13	V
V <sub>STOP</sub>	Stop Threshold Voltage	V <sub>cc</sub> Decreasing	7.5	8.5	9.5	V
$HY_{\text{UVLO}}$	UVLO Hysteresis		3.0	3.5	4.0	V
Vz	Zener Voltage	I <sub>CC</sub> =20 mA	20	22	24	V
Vop	Recommended Operating Range		13		20	V
Supply Curr	rent Section					
I <sub>START</sub>	Startup Supply Current	V <sub>CC</sub> =V <sub>START</sub> -0.2 V		120	190	μA
I <sub>OP</sub>	Operating Supply Current	Output Not Switching		1.5	3.0	mA
I <sub>DOP</sub>	Dynamic Operating Supply Current	50 kHZ, C <sub>I</sub> =1 nF		2.5	4.0	mA
IOPDIS	Operating Current at Disable	V <sub>INV</sub> =0 V	90	160	230	μA
Error Ampli	fier Section					
V <sub>REF1</sub>	Voltage Feedback Input Threshold1	T <sub>A</sub> =25°C	2.465	2.500	2.535	V
$\Delta V_{REF1}$	Line Regulation	V <sub>CC</sub> =14 V~20 V		0.1	10.0	mV
$\Delta V_{REF2}$	Temperature Stability of V <sub>REF1</sub> <sup>(4)</sup>			20		mV
I <sub>EA,BS</sub>	Input Bias Current	V <sub>INV</sub> =1 V~4 V	-0.5		0.5	μA
I <sub>EAS,SR</sub>	Output Source Current	V <sub>INV</sub> =V <sub>REF</sub> -0.1 V		-12		μA
I <sub>EAS,SK</sub>	Output Sink Current	V <sub>INV</sub> =V <sub>REF</sub> +0.1 V		12		μA
V <sub>EAH</sub>	Output Upper Clamp Voltage	V <sub>INV</sub> =1 V, V <sub>CS</sub> =0 V	6.0	6.5	7.0	V
V <sub>EAZ</sub>	Zero Duty Cycle Output Voltage		0.9	1.0	1.1	V
g <sub>m</sub>	Transconductance <sup>(4)</sup>		90	115	140	µmho
Maximum O	n-Time Section					
t <sub>ON,MAX1</sub>	Maximum On-Time Programming 1	T <sub>A</sub> =25°C, V <sub>ZCD</sub> =1 V	35.5	41.5	47.5	μs
t <sub>ON,MAX2</sub>	Maximum On-Time Programming 2	T <sub>A</sub> =25°C, I <sub>ZCD</sub> =0.469 mA	11.2	13.0	14.8	μs
Current-Sen	ise Section	•				
Vcs	Current-Sense Input Threshold Voltage Limit		0.7	0.8	0.9	V
I <sub>CS,BS</sub>	Input Bias Current	V <sub>CS</sub> =0 V~1 V	-1.0	-0.1	1.0	μA
t <sub>CS,D</sub>	Current-Sense Delay to Output <sup>(4)</sup>	dV/dt=1 V/100 ns, from 0 V to 5 V		350	500	ns

Continued on the following page ....

## **Electrical Characteristics**

 $V_{CC}$  = 14 V,  $T_A$  = -40°C to +125°C, unless otherwise specified.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Zero-Curr	rent Detect Section		•			
V <sub>ZCD</sub>	Input Voltage Threshold <sup>(4)</sup>		1.35	1.50	1.65	V
$HY_{ZCD}$	Detect Hysteresis <sup>(4)</sup>		0.05	0.10	0.15	V
V <sub>CLAMPH</sub>	Input High Clamp Voltage	I <sub>DET</sub> =3 mA	5.5	6.2	7.5	V
V <sub>CLAMPL</sub>	Input Low Clamp Voltage	I <sub>DET</sub> = -3 mA	0	0.65	1.00	V
I <sub>ZCD,BS</sub>	Input Bias Current	V <sub>ZCD</sub> =1 V~5 V	-1.0	-0.1	1.0	μA
I <sub>ZCD,SR</sub>	Source Current Capability <sup>(4)</sup>	T <sub>A</sub> =25°C			-4	mA
I <sub>ZCD,SK</sub>	Sink Current Capability <sup>(4)</sup>	T <sub>A</sub> =25°C			10	mA
t <sub>ZCD,D</sub>	Maximum Delay From ZCD to Output Turn-On <sup>(4)</sup>	dV/dt=-1 V/100 ns, 5 V to 0 V	100		200	ns
Output Se	ection					
V <sub>он</sub>	Output Voltage High	I <sub>O</sub> =-100 mA, T <sub>A</sub> =25°C	9.2	11.0	12.8	V
V <sub>OL</sub>	Output Voltage Low	I <sub>O</sub> =200 mA, T <sub>A</sub> =25°C		1.0	2.5	V
t <sub>RISE</sub>	Rising Time <sup>(4)</sup>	C <sub>IN</sub> =1 nF		50	100	ns
t <sub>FALL</sub>	Falling Time <sup>(4)</sup>	C <sub>IN</sub> =1 nF		50	100	ns
V <sub>O,MAX</sub>	Maximum Output Voltage	V <sub>CC</sub> =20 V, I <sub>O</sub> =100 µA	11.5	13.0	14.5	V
V <sub>O,UVLO</sub>	Output Voltage with UVLO Activated	V <sub>CC</sub> =5 V, I <sub>O</sub> =100 μA			1	V
Restart / I	Maximum Switching Frequency Limit S	Section				
t <sub>RST</sub>	Restart Timer Delay		50	150	300	μs
f <sub>MAX</sub>	Maximum Switching Frequency <sup>(4)</sup>		250	300	350	kHz
RDY Pin (	(FL7930C Only)					
I <sub>RDY,SK</sub>	Output Sink Current		1	2	4	mA
V <sub>RDY,SAT</sub>	Output Saturation Voltage	I <sub>RDY,SK</sub> =2 mA		320	500	mV
I <sub>RDY,LK</sub>	Output Leakage Current	Output High Impedance			1	μA
Soft-Start	Timer Section			1		
tss	Internal Soft-Soft <sup>(4)</sup>		3	5	7	ms
Protection	ns					
V <sub>OVP,INV</sub>	OVP Threshold Voltage at INV Pin	T <sub>A</sub> =25°C	2.620	2.675	2.730	V
HY <sub>OVP,INV</sub>	OVP Hysteresis at INV Pin	T <sub>A</sub> =25°C	0.120	0.175	0.230	V
V <sub>OVP,OVP</sub>	OVP Threshold Voltage at OVP Pin (FL7930B Only)	T <sub>A</sub> =25°C	2.740	2.845	2.960	V
HY <sub>OVP,OVP</sub>	OVP Hysteresis at OVP Pin (FL7930B Only)	T <sub>A</sub> =25°C		0.345		V
V <sub>EN</sub>	Enable Threshold Voltage		0.40	0.45	0.50	V
$HY_{EN}$	Enable Hysteresis		0.05	0.10	0.15	V
T <sub>SD</sub>	Thermal Shutdown Temperature <sup>(4)</sup>		125	140	155	°C
T <sub>HYS</sub>	Hysteresis Temperature of TSD <sup>(4)</sup>			60		°C

## Note:

4. These parameters, although guaranteed by design, are not production tested.

Function	FL6961	FL7930B	FL7930C	Advantages
				No External Circuit for Additional OVP
OVP Pin	None	Integrated	None	<ul> <li>Reduced Power Loss and BOM Cost Due to Additional OVP Circuit</li> </ul>
				No External Circuit for PFC Output UVLO
PFC Ready Pin	None	None	Integrated	<ul> <li>Reduced Power Loss and BOM Cost Due to PFC Out UVLO Circuit</li> </ul>
				<ul> <li>Versatile Open-Drain Pin</li> </ul>
				<ul> <li>Abnormal CCM Operation Prohibited</li> </ul>
Frequency Limit	None	Integrated	Integrated	<ul> <li>Abnormal Inductor Current Accumulation Can Be Prohibited</li> </ul>
AC Absent				<ul> <li>Increased System Reliability with AC On-Off Test</li> </ul>
Detection	None	Integrated	Integrated	<ul> <li>Guaranteed Stable Operation at Short Electric Power Failure</li> </ul>
Soft-Start and				<ul> <li>Reduced Voltage and Current Stress at Startup</li> </ul>
Startup without Overshoot	None	Integrated	Integrated	<ul> <li>Eliminates Audible Noise due to Unwanted OVP Triggering</li> </ul>
Control Range	Nana	Interneted		<ul> <li>Can Avoid Burst Operation at Light Load and High Input Voltage</li> </ul>
Compensation	None	Integrated	Integrated	<ul> <li>Reduced Probability of Audible Noise Due to the Burst Operation</li> </ul>
THD Optimizer	External	Internal	Internal	No External Resistor is Needed
TOD			Integrate d	<ul> <li>Stable and Reliable TSD Operation</li> </ul>
TSD	None	Integrated	Integrated	<ul> <li>Converter Temperature Range Limited Range</li> </ul>

# Comparison of FL7930B and FL7930C

Function	FL7930B	FL7930C	Remark
RDY Pin	None	Integrated	<ul> <li>User Choice for the Use of Pin #2 FL7930B: OVP</li> </ul>
OVP Pin	Integrated	None	FL7930C: RDY
Control Range Compensation	Integrated	Integrated	





Figure 9. Stop Threshold Voltage (VSTOP) vs. TA



Figure 11. Operating Supply Current (IOP) vs. TA



Figure 10. Startup Supply Current (ISTART) vs. TA



Figure 12. Output Upper Clamp Voltage (VEAH) vs. TA

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## **Applications Information**

1. Startup: Normally, supply voltage ( $V_{CC}$ ) of a PFC block is fed from the additional power supply, which can be called standby power. Without this standby power, auxiliary winding for zero current detection can be used as a supply source. Once the supply voltage of the PFC block exceeds 12 V, internal operation is enabled until the voltage drops to 8.5 V. If V<sub>CC</sub> exceeds V<sub>Z</sub>, 20 mA current is sinking from V<sub>CC</sub>.



Figure 25. Startup Circuit

**2. INV Block**: Scaled-down voltage from the output is the input for the INV pin. Many functions are embedded based on the INV pin: transconductance amplifier, output OVP comparator, and disable comparator.

For the output voltage control, a transconductance amplifier is used instead of the conventional voltage amplifier. The transconductance amplifier (voltagecontrolled current source) aids the implementation of OVP and disable functions. The output current of the amplifier changes according to the voltage difference of the inverting and non-inverting input of the amplifier. To cancel down the line input voltage effect on power factor correction, effective control response of PFC block should be slower than the line frequency. This conflicts with the transient response of controller. Two-pole onezero type compensation may be used to meet both requirements.

The OVP comparator shuts down the output drive block when the voltage of the INV pin is higher than 2.675 V with 0.175 V hysteresis. The disable comparator disables operation when the voltage of the inverting input is lower than 0.35 V with 100 mV hysteresis. An external small-signal MOSFET can be used to disable the IC. The IC operating current decreases to reduce power consumption if the IC is disabled. Figure 27 is the timing chart of the internal circuit near the INV pin when rated-PFC output voltage is assumed at 390 V<sub>DC</sub> and V<sub>CC</sub> supply voltage is 15 V.



Figure 27. Timing Chart for INV Block

3. OVP Pin: Over-Voltage Protection (OVP) is embedded by the information at the INV pin. That information comes from the output through the voltage dividing resistors. To scale down from high voltage to low voltage, high resistance normally replaced with low resistance. If the resistor of high resistance is damaged and resistance is changed to high, INV pin information is normal, but output voltage exceeds its rated output. Once this occurs, output electrolytic capacitor may be damaged. The FL3930B provides an additional OVP pin that can be used to shut down the boost power stage when output voltage exceeds the OVP level if the resistors connected at the INV pin are damaged. To prevent such a catastrophe, an additional OVP pin is assigned to double check output voltage. The additional OVP may be called second OVP, while INV pin OVP can be called the first OVP. Since the two OVP conditions are quite different, the protection recovery modes are different.

Once the first OVP triggers, switching stops immediately and recovers switching when the output voltage is decreased with a hysteresis. When the second OVP triggers, switching can be recovered only when the V<sub>CC</sub> supply voltage falls below V<sub>STOP</sub> and builds up higher than V<sub>START</sub> again and V<sub>OVP</sub> is lower than hysteresis. If the second OVP is not used, the OVP pin must be connected to the INV pin or to ground.



Figure 28. Comparison of First and Second OVP Recovery Modes

4. RDY Output: The FL7930C provides a PFC-ready pin that can be used to trigger other power stages when PFC output voltage reaches the proper level with hysteresis. When the INV voltage is higher than 2.24 V, RDY out is triggered HIGH and lasts until the INV voltage is lower than 2.051 V. When input AC voltage is quite high, for example 240 VAC, PFC output voltage is always higher than RDY threshold, regardless of boost converter operation. In this case, the INV voltage is already higher than 2.24 V before PFC V<sub>CC</sub> touches V<sub>START</sub>. After boost converter operation stops, RDY is not pulled LOW because the INV voltage is higher than the RDY threshold. When V<sub>CC</sub> of the PFC drops below 5 V, RDY is pulled LOW even through PFC output voltage is higher than threshold. The RDY pin output is open-drain, so needs an external pull-up resistor to supply the proper power source. The RDY pin output remains floating until V<sub>CC</sub> is higher than 2 V.





Figure 30. Two Cases of RDY Triggered LOW

**5. Control Range Compensation**: On time is controlled by the output voltage compensator. When input voltage is high and load is light, the control range becomes narrow compared to when input voltage is low. That control range decrease is anti-proportional to the double square of the input voltage. Thus, at high line, unwanted burst operation can occur at light load and audible noise may be generated from the boost inductor or inductor at input filter. Unlike other converters, burst operation in PFC block is not needed because the PFC block itself is normally disabled in Standby Mode. To reduce unwanted burst operation at light load, internal control range compensation is implemented and no burst operation occurs until 5% load at high line.

**6.** Zero-Current Detection: Zero-Current Detection (ZCD) generates the turn-on signal of the MOSFET when the boost inductor current reaches zero using an auxiliary winding coupled with the inductor. When the power switch turns on, negative voltage is induced at the auxiliary winding due to the opposite winding direction (see Equation (1)) and positive voltage is induced (see Equation (2)) when the power switch turns off.

$$V_{AUX} = -\frac{T_{AUX}}{T_{IND}} \cdot V_{AC}$$
(1)

$$V_{AUX} = \frac{T_{AUX}}{T_{IND}} \cdot \left( V_{PFCOUT} - V_{AC} \right)$$
(2)

where  $V_{AUX}$  is the auxiliary winding voltage;  $T_{\text{IND}}$  and  $T_{AUX}$  are boost inductor turns and auxiliary winding turns, respectively;  $V_{AC}$  is input voltage for PFC converter; and  $V_{OUT\_PFC}$  is output voltage from the PFC converter.



Figure 31. Circuit Near ZCD

Because auxiliary winding voltage can swing from negative voltage to positive voltage, the internal block in the ZCD pin has both positive and negative voltage clamping circuits. When the auxiliary voltage is negative, an internal circuit clamps the negative voltage at the ZCD pin around 0.65 V by sourcing current to the serial resistor between the ZCD pin and the auxiliary winding. When the auxiliary voltage is higher than 6.5 V, the FL7390 sinks current through a resistor from the auxiliary winding to the ZCD pin.



on MOSFET Switching

To check the boost inductor current zero instance, auxiliary winding voltage is used. When boost inductor current becomes zero, there is a resonance between boost inductor and all capacitors at MOSFET drain pin, including Coss of the MOSFET; an external capacitor at the D-S pin to reduce the voltage rising and falling slope of the MOSFET: a parasitic capacitor at inductor: and so on to improve performance. Resonated voltage is reflected to the auxiliary winding and can be used for detecting zero current of boost inductor and valley position of MOSFET voltage stress. For valley detection, a minor delay by the resistor and capacitor is needed. A capacitor increases the noise immunity at the ZCD pin. If ZCD voltage is higher than 1.5 V, an internal ZCD comparator output becomes HIGH and LOW when the ZCD goes below 1.4 V. At the falling edge of comparator output, internal logic turns on the MOSFET.



When no ZCD signal is available, the PFC controller cannot turn on the MOSFET, so the controller checks every switching off time and forces MOSFET turn on when the off time is longer than 150  $\mu$ s. This is called restart timer. The restart timer triggers MOSFET turn-on at startup and may be used at the input voltage-zero cross period.



Because the MOSFET turn on depends on the ZCD input, switching frequency may increase to higher than several megahertz due to mis-triggering or noise on the nearby ZCD pin. If the switching frequency is higher than needed for critical conduction mode (CRM). operation mode shifts to continuous conduction mode (CCM). In CCM, unlike CRM where the boost inductor current is reset to zero at the next switch on; inductor current builds up at every switching cycle and can be raised to high current that exceeds the current rating of the power switch or diode. This can seriously damage the power switch and result in burn down. To avoid this, maximum switching frequency limitation is embedded. If ZCD signal is applied again within 3.3 µs after the previous rising edge of the gate signal, this signal is ignored internally and FL7930 waits for another ZCD signal. This slightly degrades the power factor performance at light load and high input voltage.



**7. Control**: The scaled output is compared with the internal reference voltage and sinking or sourcing current is generated from the COMP pin by the transconductance amplifier. The error amplifier output is compared with the internal sawtooth waveform to give proper turn-on time based on the controller.



Figure 36. Control Circuit

Unlike a conventional voltage-mode PWM controller, FL7930 turns on the MOSFET at the falling edge of ZCD signal. On instance is decided by the external signal and the turn-on time lasts until the error amplifier output (V<sub>COMP</sub>) and sawtooth waveform meet. When load is heavy, output voltage decreases, scaled output decreases, COMP voltage increases to compensate low output, turn-on time lengthens to give more inductor turn-on time, and increased inductor current raises the output voltage. This is how PFC negative feedback controller regulates output.

The maximum of  $V_{COMP}$  is limited to 6.5 V, which dictates the maximum turn-on time, and switching stops when  $V_{COMP}$  is lower than 1.0 V.



Figure 37. Turn-On Time Determination

The roles of PFC controller are regulating output voltage and input current shaping to increase power factor. Duty control based on the output voltage should be fast enough to compensate output voltage dip or overshoot. For the power factor, however, the control loop must not react to the fluctuating AC input voltage. These two requirements conflict; therefore, when designing a feedback loop, the feedback loop should be least ten times slower than AC line frequency. That slow response is made by C1 at compensator. R1 makes gain boost around operation region and C2 attenuates gain at higher frequency. Boost gain by R1 helps raise the response time and improves phase margin.



For the transconductance error amplifier side, gain

changes based on differential input. When the error is large, gain is large to force the output dip or peak to suppress quickly. When the error is small, low gain is used to improve power factor performance.



**8.** Soft-Start: When  $V_{CC}$  reaches  $V_{START}$ , an internal reference voltage is increased like a stair step for 5 ms. As a result,  $V_{COMP}$  is also raised gradually and MOSFET turn-on time increases smoothly. This reduces voltage and current stress on the power switch during startup.



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9. Startup without Overshoot: Feedback control speed of PFC is quite slow. Due to the slow response, there is a gap between output voltage and feedback control. That is why over-voltage protection (OVP) is critical at the PFC controller and voltage dip caused by fast load changes from light to heavy is diminished by a bulk capacitor. OVP is easily triggered during startup phase. Operation on and off by OVP at startup may cause audible noise and can increase voltage stress at startup, which is normally higher than in normal operation. This operation is better when soft-start time is very long; however, too much startup time enlarges the output voltage building time at light load. FL7930 has less overshoot prevention at startup. During startup, the feedback loop is controlled by an internal proportional gain controller. When the output voltage reaches the rated value, it switches to an external compensator after a transition time of 30 ms. In short, an internal proportional gain controller eliminates overshoot at startup and an external conventional compensator takes over successfully afterward.



Figure 41. Startup with Overshoot Prevention

10. THD Optimization: Total Harmonic Distortion (THD) is the factor that dictates how closely the input current shape matches sinusoidal form. The turn-on time of the PFC controller is almost constant over one AC line period due to the extremely low feedback control response. The turn-off time is determined by the current decrease slope of the boost inductor made by the input voltage and output voltage. Once inductor current becomes zero, resonance between C<sub>OSS</sub> and the boost inductor makes oscillating waveforms at the drain pin and auxiliary winding. By checking the auxiliary winding voltage through the ZCD pin, the controller can check the zero current of the boost inductor. At the same time, a minor delay is inserted to determine the valley position of drain voltage. The input and output voltage difference is at its maximum at the zero-cross point of the AC input voltage. The current decrease slope is steep near the zero-cross region and more negative inductor current flows during a drain voltage valley-detection time. Such a negative inductor current cancels down the positive current flows and input current becomes zero, called "zero-cross distortion" in PFC.



Figure 42. Input and Output Current Near Input Voltage Peak



### Figure 43. Input and Output Current Near Input Voltage Peak Zero Cross

To improve this, lengthened turn-on time near the zerocross region is a well-known technique, though the method may be different from company to company and may be proprietary. FL7930 accomplishes this by sourcing current through the ZCD pin. Auxiliary winding voltage becomes negative when the MOSFET turns on and is proportional to input voltage. The negative clamping circuit of ZCD outputs the current to maintain the ZCD voltage at a fixed value. The sourcing current from the ZCD is directly proportional to the input voltage. Some portion of this current is applied to the internal sawtooth generator, together with a fixedcurrent source. Theoretically, the fixed-current source and the capacitor at sawtooth generator decide the maximum turn-on time when no current is sourcing at ZCD clamp circuit and available turn-on time gets shorter proportional to the ZCD sourcing current.



By THD optimizer, turn-on time over one AC line period is proportionally changed, depending on input voltage. Near the zero cross, lengthened turn-on time improves THD performance.

11. Input Voltage Absent Detection: To save power loss caused by input voltage-sensing resistors and to optimize THD, FL7930 omits AC input voltage detection. Therefore, no information about AC input is available from the internal controller. In many cases, the V<sub>CC</sub> of PFC controller is supplied by an independent power source, like standby power. In this scheme, some mismatch may exist. For example, when the electric power is suddenly interrupted during two or three AC line periods; V<sub>CC</sub> is still alive during that time, but output voltage drops because there is no input power source. Consequently, the control loop tries to compensate for the output voltage drop and  $V_{\text{COMP}}$  reaches its maximum. This lasts until AC input voltage is live again. When AC input voltage is live again, high V<sub>COMP</sub> allows high switching current and more stress is put on the MOSFET and diode. To protect against this, FL7930 internally checks if the input AC voltage exists. If input

does not exist, soft-start is reset and waits until AC input is live again. Soft-start manages the turn-on time for smooth operation when it detects AC input is applied, which applies less voltage and current stress on startup.



**12. Current Sense**: The MOSFET current is sensed using an external sensing resistor for the over-current protection. If the CS pin voltage is higher than 0.8 V, the over-current protection comparator generates a protection signal. An internal RC filter of 40 k $\Omega$  and 8 pF is included to filter switching noise.

**13. Gate Driver Output**: FL7930 contains a single totem-pole output stage designed for a direct drive of the power MOSFET. The drive output is capable of up to +500/-800 mA peak current with a typical rise and fall time of 50 ns with 1 nF load. The output voltage is clamped to 13 V to protect the MOSFET gate even if the  $V_{CC}$  voltage is higher than 13 V.

### 14. PCB Layout

PFC block normally handles high switching current and the voltage low-energy signal path can be affected by the high-energy path. Cautious PCB layout is mandatory for stable operation.

- The gate drive path should be as short as possible. The closed-loop that starts from the gate driver, MOSFET gate, and MOSFET source to ground of PFC controller is recommended as close as possible. This is also the crossing point between power ground and signal ground. Power ground path from the bridge diode to the output bulk capacitor should be short and wide. The sharing position between power ground and signal ground should be only at one position to avoid ground loop noise. Signal path of PFC controller should be short and wide for external components to contact.
- PFC output voltage sensing resistor is normally high to reduce current consumption. This path can be affected by external noise. To reduce noise possibility at the INV pin, a shorter path for output sensing is recommended. If a shorter path is not possible, place some dividing resistors between PFC output and the INV pin — closer to the INV pin is better. Relative high voltage close to the INV pin can be helpful.

- ZCD path is recommended close to auxiliary winding from boost inductor and to the ZCD pin. If that is difficult, place a small capacitor (below 50 pF) to reduce noise.
- Switching current-sense path should not share with any other path to avoid interference. Some additional components may be needed to reduce the noise level applied to the CS pin.
- A stabilizing capacitor for V<sub>CC</sub> is recommended as close as possible to the V<sub>CC</sub> and ground pins. If it is difficult, place the SMD capacitor as close to the corresponding pins as possible.



Figure 48. Recommended PCB Layout



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— Single-Stage Flyback and Boundary-Mode PFC Controller for Lighting